

2.5 MHz, Fixed-Output, Synchronous TinyBoost[®] Regulator

FAN48618

The FAN48618 is a low-power boost regulator designed to provide a minimum voltage regulated rail from a standard single-cell Li-Ion battery and advanced battery chemistries. Even below the minimum system battery voltage, the device maintains output voltage regulation. The combination of built-in power transistors, synchronous rectification, and low supply current suit the FAN48618 for battery-powered applications.

The FAN48618 is available in a 9-bump, 0.4 mm pitch, Wafer-Level Chip-Scale Package (WLCSP).

Features

- Input Voltage Range: 2.7 V to 4.8 V
- Output Voltage: 5.25 V
- Internal Synchronous Rectification
- True Load Disconnect
- Short-Circuit Protection
- 9-Bump, 1.215 mm x 1.215 mm, 0.4 mm Pitch, WLCSP
- Three External Components: 2012 0.47 μ H Inductor, 0402 4.7 μ F Input Capacitor, 0603 22 μ F Output Capacitor

Applications

- Class-D Audio Amplifier and USB OTG Supply
- Boost for Low-Voltage Li-Ion Batteries
- Smart Phones, Tablets, Portable Devices, and Wearables

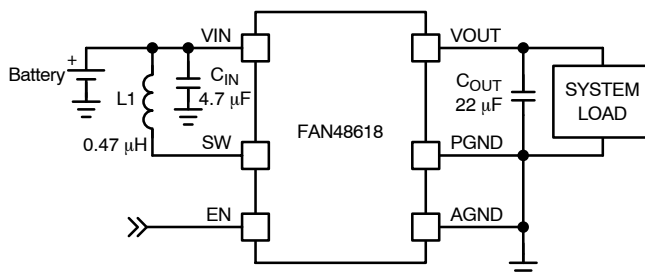
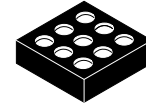
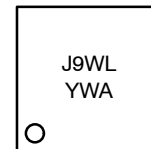


Figure 1. Typical Application



WLCSP9 1.215x1.215x0.581
CASE 567QW

MARKING DIAGRAM



J9 = Device Code
 WL = Wafer Lot Number
 YW = Assembly Start Week
 A = Assembly Site

ORDERING INFORMATION

See detailed ordering and shipping information on page 10 of this data sheet.

FAN48618

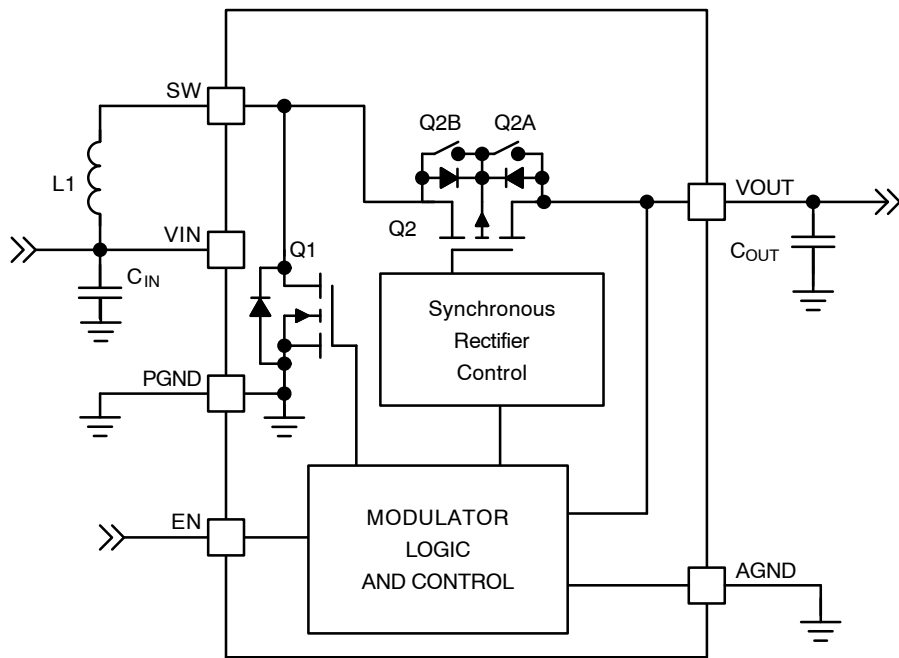


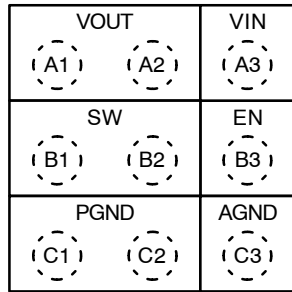
Figure 2. IC Block Diagram

RECOMMENDED COMPONENTS

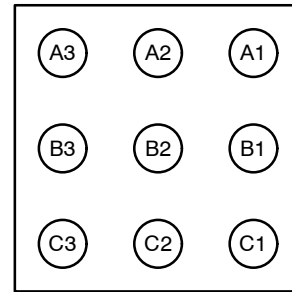
Component	Description	Vendor	Parameter	Typ	Unit
L1	2012, 4.0 A, 0.8 mm Max. Height	CIGT201208EMR47SNE SEMCO	L	0.47	μH
			DCR (Series R)	37	mΩ
C _{IN}	10%, 10 V, X5R, 0402	CL05A475KP5NRNC SEMCO	C	4.7	μF
C _{OUT}	20%, 10 V, X5R, 0603	CL10A226MP8NUNE SEMCO	C	22	μF

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PIN CONFIGURATION



**Figure 3. Bumps Facing Down
(Top View)**



**Figure 4. Bumps Facing Up
(Bottom View)**

PIN DEFINITIONS

Pin No.	Symbol	Description
A1, A2	VOUT	<i>Output Voltage.</i> This pin is the output voltage terminal; connect directly to C _{OUT} .
A3	VIN	<i>Input Voltage.</i> Connect to the Li-Ion battery input power source and the bias supply for the gate drivers.
B1, B2	SW	<i>Switching Node.</i> Connect to inductor.
B3	EN	<i>Enable.</i> When this pin is HIGH, the circuit is enabled. It is recommended to connect and set to a logic voltage of 1.8 V after UVLO has been satisfied.
C1, C2	PGND	<i>Power Ground.</i> This is the power return for the IC. C _{OUT} capacitor should be returned with the shortest path possible to these pins.
C3	AGND	<i>Analog Ground.</i> This is the signal ground reference for the IC. All voltage levels are measured with respect to this pin. Connect to PGND at a single point.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter		Min	Max	Unit
V _{IN}	Voltage on VIN Pin		−0.3	6.0	V
V _{OUT}	Voltage on VOUT Pin		−0.3	6.0	V
V _{SW}	Voltage on SW Node	DC	−0.3	6.0	V
		Transient: 10 ns, 3 MHz	−1.0	8.0	
V _{CC}	Voltage on Other Pins		−0.3	6.0 (Note 1)	V
ESD	Electrostatic Discharge Protection Level	Human Body Model, ANSI/ESDA/JEDEC JS−001−2012	2		kV
		Charged Device Model per JESD22−C101	1		
T _J	Junction Temperature		−40	+150	°C
T _{STG}	Storage Temperature		−65	+150	°C
T _L	Lead Soldering Temperature (10 Seconds)		−	+260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Lesser of 6.0 V or $V_{IN} + 0.3$ V.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
V_{IN}	Supply Voltage		2.7	4.8	V
I_{OUT}	Output Current (Note 2)		-	1200	mA
T_A	Ambient Temperature		-40	+85	°C
T_J	Junction Temperature		-40	+125	°C

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

2. Typical 1 A and 1.2 A I_{OUT} at $V_{IN} = 2.7$ V and 3.0 V, respectively.

THERMAL PROPERTIES

Symbol	Parameter		Typ	Unit
θ_{JA}	Junction-to-Ambient Thermal Resistance		50	°C/W

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature $T_{J(max)}$ at a given ambient temperature T_A .

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ELECTRICAL SPECIFICATIONS (Recommended operating conditions, unless otherwise noted, circuit per Figure 1, $V_{OUT} = 5.25\text{ V}$, $V_{IN} = 2.7\text{ V}$ to 4.8 V , and $T_A = -40^\circ\text{C}$ to 85°C . Typical values are given $V_{IN} = 3.6\text{ V}$ and $T_A = 25^\circ\text{C}$.)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
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POWER SUPPLY

I_Q	V_{IN} Quiescent Current	$V_{IN} = 3.6\text{ V}$, $I_{OUT} = 0$, $EN = V_{IN}$	–	90	140	μA
		Shutdown: $EN = 0$, $V_{IN} = 3.7\text{ V}$, $V_{OUT} = 0\text{ V}$	–	2.7	10	
V_{UVLO}	Under-Voltage Lockout	V_{IN} Rising	–	2.2	2.3	V
V_{UVLO_HYS}	Under-Voltage Lockout Hysteresis		–	150	–	mV

INPUTS

V_{IH}	Enable HIGH Voltage		1.2	–	–	V
V_{IL}	Enable LOW Voltage		–	–	0.4	V
I_{PD}	Current Sink Pull-Down	EN Pin, Logic HIGH	–	100	–	nA
R_{LOW}	Low-State Active Pull-Down	EN Pin, Logic LOW	200	300	400	k Ω

OUTPUTS

V_{REG}	Output Voltage Accuracy DC (Note 3)	Referred to V_{OUT} , $V_{IN} = 3.0$ to 4.5 V	–2	–	4	%
I_{LK_OUT}	V_{IN} -to- V_{OUT} Leakage Current	$V_{OUT} = 0$, $EN = 0$, $V_{IN} = 2.7\text{ V}$	–	–	1	μA
I_{LK}	V_{OUT} -to- V_{IN} Reverse Leakage Current	$V_{OUT} = 5.25\text{ V}$, $EN = 0$, $V_{IN} = 2.7\text{ V}$	–	–	3.5	μA
V_{RIPPLE}	Output Ripple (Note 4)	0 mA to 1 A	–	25	–	mV

TIMING

f_{SW}	Switching Frequency	$V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.25\text{ V}$, $I_{LOAD} = 500\text{ mA}$	2.0	2.5	3.0	MHz
t_{SS}	Soft-Start EN HIGH to Regulation (Note 4)	$V_{IN} = 3.0\text{ V}$, $V_{OUT} = 5.25\text{ V}$, $I_{LOAD} = 0\text{ mA}$, $C_{OUT} = 22\text{ }\mu\text{F}$ (0603)	–	1000	–	μs
I_{SS}	Input Peak Current		–	90	200	mA
t_{RST}	FAULT Restart Timer (Note 4)		–	20	–	ms

POWER STAGE

$R_{DS(ON)N}$	N-Channel Boost Switch $R_{DS(ON)}$	$V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.25\text{ V}$	–	80	130	m Ω
$R_{DS(ON)P}$	P-Channel Sync. Rectifier $R_{DS(ON)}$	$V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.25\text{ V}$	–	65	115	m Ω
I_{V_LIM}	Boost Valley Current Limit	$V_{OUT} = 5.25\text{ V}$	–	2.3	–	A
$I_{V_LIM_SS}$	Boost Soft-Start Valley Current Limit	$V_{IN} < V_{OUT} < V_{OUT_TARGET}$	–	1.3	–	A
T_{150T}	Over-Temperature Protection (OTP)		–	150	–	$^\circ\text{C}$
T_{150H}	OTP Hysteresis		–	20	–	$^\circ\text{C}$

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. DC I_{LOAD} from 0 to 1 A. V_{OUT} measured from mid-point of output voltage ripple. Effective capacitance of $C_{OUT} \geq 5\text{ }\mu\text{F}$.

4. Guaranteed by design and characterization; not tested in production.

TYPICAL CHARACTERISTICS

(Unless otherwise specified, $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.25\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.)

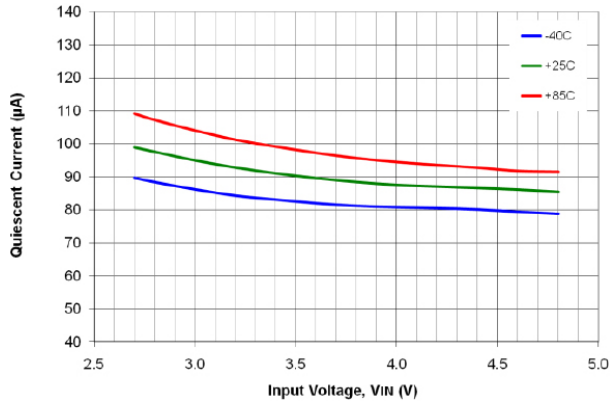


Figure 5. Quiescent Current vs. Input Voltage and Temperature

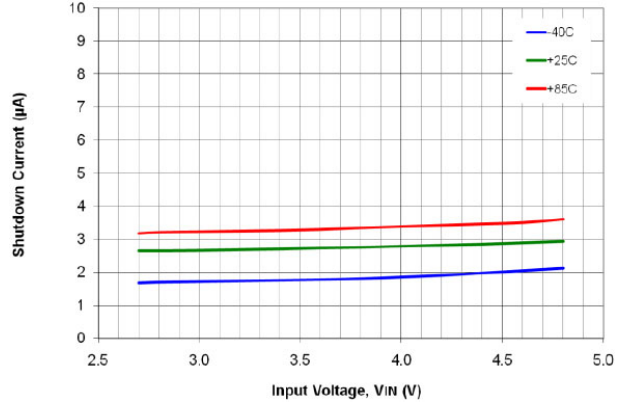


Figure 6. Shutdown Current vs. Load Current and Temperature

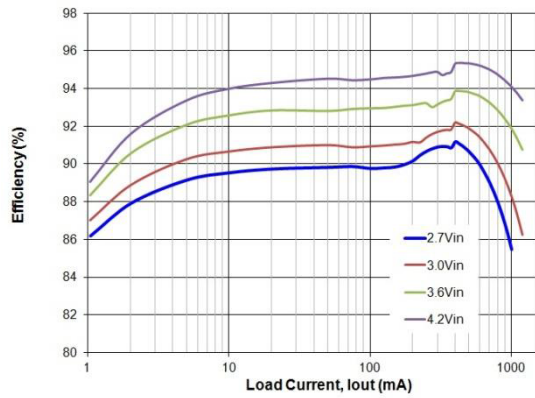


Figure 7. Efficiency vs. Load Current and Input Voltage

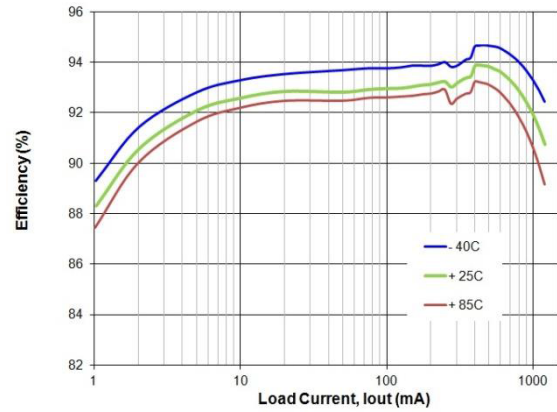


Figure 8. Efficiency vs. Load Current and Temperature

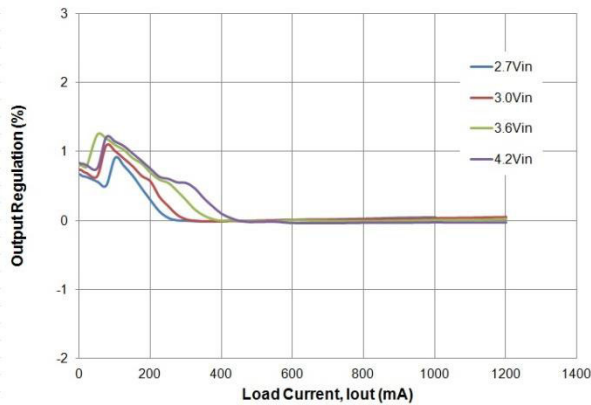


Figure 9. Output Regulation vs. Load Current and Input Voltage

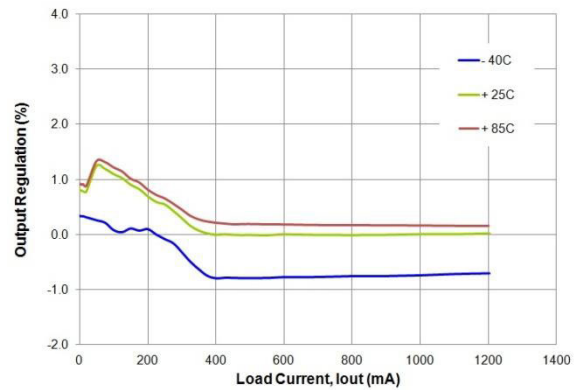


Figure 10. Output Regulation vs. Load Current and Temperature

TYPICAL CHARACTERISTICS (continued)

(Unless otherwise specified, $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.25\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.)

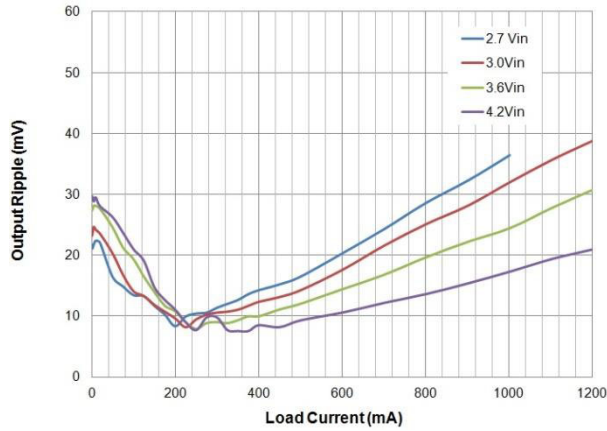


Figure 11. Output Ripple vs. Load Current and Input Voltage

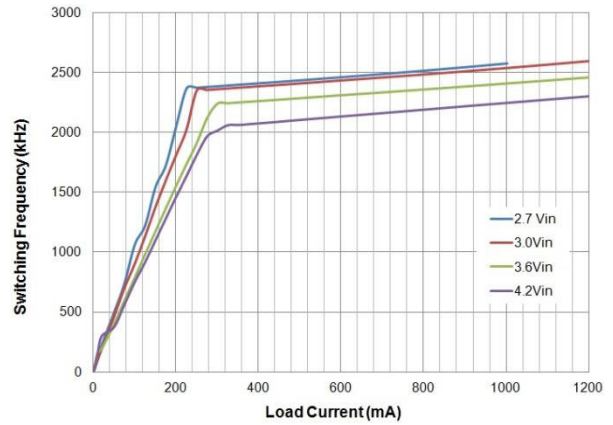


Figure 12. Switching Frequency vs. Load Current and Temperature

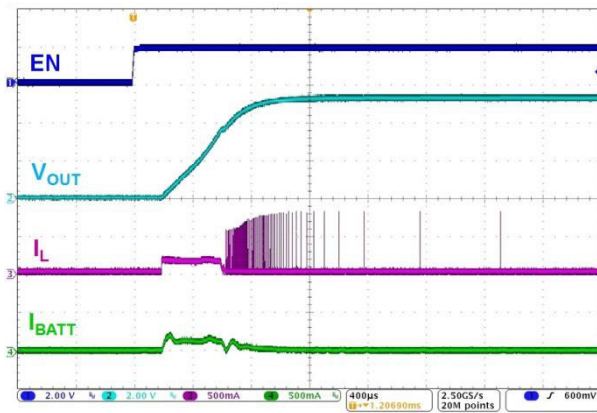


Figure 13. Startup, No Load

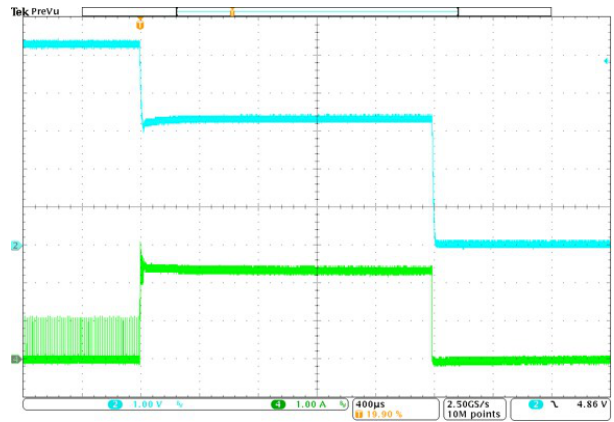


Figure 14. Overload Protection

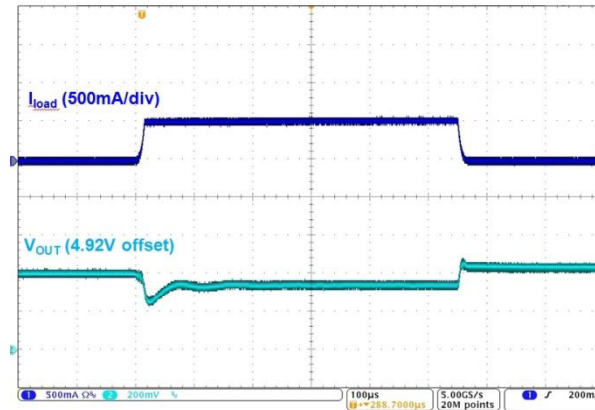


Figure 15. Load Transient, 3.8 V_{IN} , $0 \leftrightarrow 500\text{ mA}$, $8\text{ }\mu\text{s}$ Edge

FUNCTIONAL DESCRIPTION

Overview

FAN48618 is a synchronous boost regulator, typically operating at 2.5 MHz in Continuous Conduction Mode (CCM), which occurs at moderate to heavy load current and low V_{IN} voltage. Typically, 1 A and 1.2 A output currents can be obtained at input voltages ≥ 2.7 V and ≥ 3.0 V, respectively. Passive component derating must be taken into consideration, as well as, thermal properties of the regulator.

Table 1. OPERATING MODES

Mode	Description	Invoked When:
LIN	Linear Startup	$V_{IN} > V_{OUT}$
SS	Boost Soft-Start	$V_{IN} < V_{OUT} < V_{OUT(TARGET)}$
BST	Boost Mode	$V_{OUT} = V_{OUT(TARGET)}$

Table 2. BOOST STARTUP SEQUENCE

Start Mode	Entry	Exit	End Mode	Timeout (μ s)
LIN1	$V_{IN} > V_{UVLO}$, EN = 1	$V_{OUT} > V_{IN} - 300$ mV	SS	
		TIMEOUT	LIN2	512
LIN2	LIN1 Exit	$V_{OUT} > V_{IN} - 300$ mV	SS	
		TIMEOUT	FAULT	1024
SS	LIN1 or LIN2 Exit	$V_{OUT} = V_{OUT(TARGET)}$	BST	
		OVERLOAD TIMEOUT	FAULT	64

Linear Startup (LIN) Mode

When EN is HIGH and $V_{IN} > V_{UVLO}$, the regulator attempts to bring V_{OUT} within 300 mV of V_{IN} using the internal fixed current source from V_{IN} (Q2). The current is limited to the I_{SS} set point, which is typically 90 mA. The linear charging current is limited to a maximum of 200 mA to prevent any “brownout” situations where the system voltage drops too low. During LIN1 Mode, if V_{OUT} reaches $V_{IN}-300$ mV, SS Mode is initiated. Otherwise, LIN1 Mode expires after 512 μ s and LIN2 Mode is entered. In LIN2 Mode, the current source is equal to LIN1 current source I_{SS} , typically 90 mA. If V_{OUT} fails to reach $V_{IN}-300$ mV after 1024 μ s, a fault condition is declared and the device waits 20 ms (t_{RST}) to attempt an automatic restart.

Soft-Start (SS) Mode

Upon the successful completion of LIN Mode ($V_{OUT} \geq V_{IN}-300$ mV), the regulator begins switching with boost pulses current limited to 50% of nominal level. During SS Mode, if V_{OUT} fails to reach regulation during the SS ramp sequence for more than 64 μ s, a fault is declared. If a large C_{OUT} is used, the reference is automatically stepped slower to avoid excessive input current draw.

Boost Mode Regulation

The current-mode modulator achieves excellent transient response and smooth transitions between CCM and DCM operation. During CCM operation, the device maintains a switching frequency of about 2.5 MHz. In light-load operation (DCM), frequency is naturally reduced to maintain high efficiency.

Startup and Shutdown

When EN is LOW, all bias circuits are off and the regulator enters Shutdown Mode. During shutdown, current flow is prevented from V_{IN} to V_{OUT} , as well as reverse flow from V_{OUT} to V_{IN} . It is recommended to keep load current draw below 50 mA until the device successfully executes startup. The following table describes the startup sequence.

Boost (BST) Mode

This is the normal operating mode of the regulator.

Fault State

The regulator enters Fault State under any of the following conditions:

- V_{OUT} fails to achieve the voltage required to advance from LIN Mode to SS Mode.
- V_{OUT} fails to achieve the voltage required to advance from SS Mode to BST Mode.
- Boost current limit triggers for 2 ms during BST Mode.
- $V_{IN} - V_{OUT} > 300$ mV; this fault can only occur after successful completion of the soft-start sequence.
- $V_{IN} < V_{UVLO}$

Once a fault is triggered, the regulator stops switching and presents a high-impedance path between V_{IN} and V_{OUT} . After waiting 20 ms, an automatic restart is attempted.

Over-Temperature Protection

The regulator shuts down if the die temperature exceeds 150°C. Restart occurs when the IC has cooled by approximately 20°C.

APPLICATION INFORMATION

Output Capacitance (C_{OUT})

The effective capacitance (C_{EFF} (Note 5)) of small, high-value ceramic capacitors decreases as their bias voltage increases, as illustrated in the graph below:

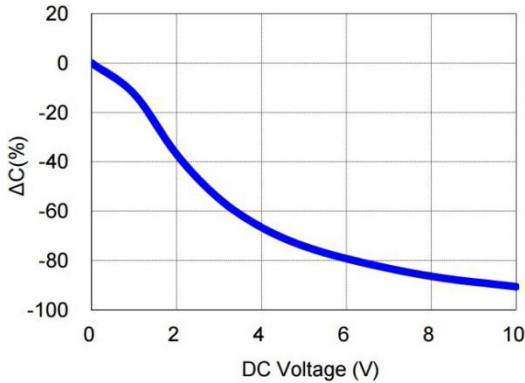


Figure 16. C_{EFF} for 22 μ F, 0603, X5R, 10 V-Rated Capacitor (SEMCO CL10A226MP8NUNE)

FAN48618 is guaranteed for stable operation with the typical value of C_{EFF} outlined in the table below.

Table 3. TYPICAL C_{EFF} REQUIRED FOR STABILITY

Operating Conditions			C_{EFF} (μ F)
V_{OUT} (V)	V_{IN} (V)	I_{LOAD} (mA)	
5.25	2.7 to 4.5	0 to 1000	5

5. C_{EFF} varies by manufacturer, capacitor material, and case size.

Inductor Selection

Recommended nominal inductance value is 0.47 μ H.

The FAN48618 employs valley-current limiting, so peak inductor current can reach 3.6 A for a short duration during overload conditions. Saturation causes the inductor current ripple to increase under high loading, as only the valley of the inductor current ripple is controlled.

Startup

Input current limiting is active during soft-start, which limits the current available to charge C_{OUT} and any additional capacitance on the V_{OUT} line. If the output fails

to achieve regulation within the limits described in the Soft-Start section above, a fault occurs, causing the circuit to shut down. It waits about 20 ms before attempting a restart. If the total combined output capacitance is very high, the circuit may not start on the first attempt, but eventually achieves regulation if no load is present. If a high current load and high capacitance are both present during soft-start, the circuit may fail to achieve regulation and continually attempt soft-start, only to have the output capacitance discharged by the load when in Fault State.

Output Voltage Ripple

Output voltage ripple is inversely proportional to C_{OUT} . During t_{ON} , when the boost switch is on, all load current is supplied by C_{OUT} .

$$V_{RIPPLE(P-P)} = t_{ON} \cdot \frac{I_{LOAD}}{C_{OUT}} \quad (\text{eq. 1})$$

and

$$t_{ON} = t_{SW} \cdot D = t_{SW} \cdot \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \quad (\text{eq. 2})$$

therefore:

$$V_{RIPPLE(P-P)} = t_{SW} \cdot \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \cdot \frac{I_{LOAD}}{C_{OUT}} \quad (\text{eq. 3})$$

where:

$$t_{SW} = \frac{1}{f_{SW}} \quad (\text{eq. 4})$$

The maximum V_{RIPPLE} occurs when V_{IN} is minimum and I_{LOAD} is maximum. For better ripple performance, more output capacitance can be added.

Layout Recommendations

The layout recommendations below highlight various topcopper pours by using different colors. To minimize spikes at V_{OUT} , C_{OUT} must be placed as close as possible to PGND and V_{OUT} , as shown below. For best thermal performance, maximize the pour area for all planes other than SW. The ground pour, especially, should fill all available PCB surface area and be tied to internal layers with a cluster of thermal vias.

FAN48618

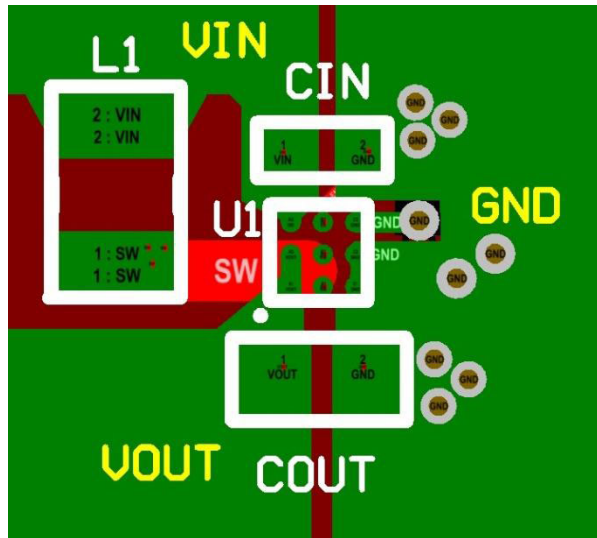


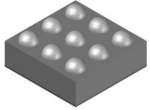
Figure 17. Layout Recommendation

ORDERING INFORMATION

Part Number	Device Marking	V _{OUT}	Operating Temperature Range	Package	Shipping [†]
FAN48618BUC53X	J9	5.25 V	–40°C to 85°C	9-Bump, 0.4 mm Pitch, Wafer-Level Chip-Scale Package (WLCSP)	3000 / Tape & Reel

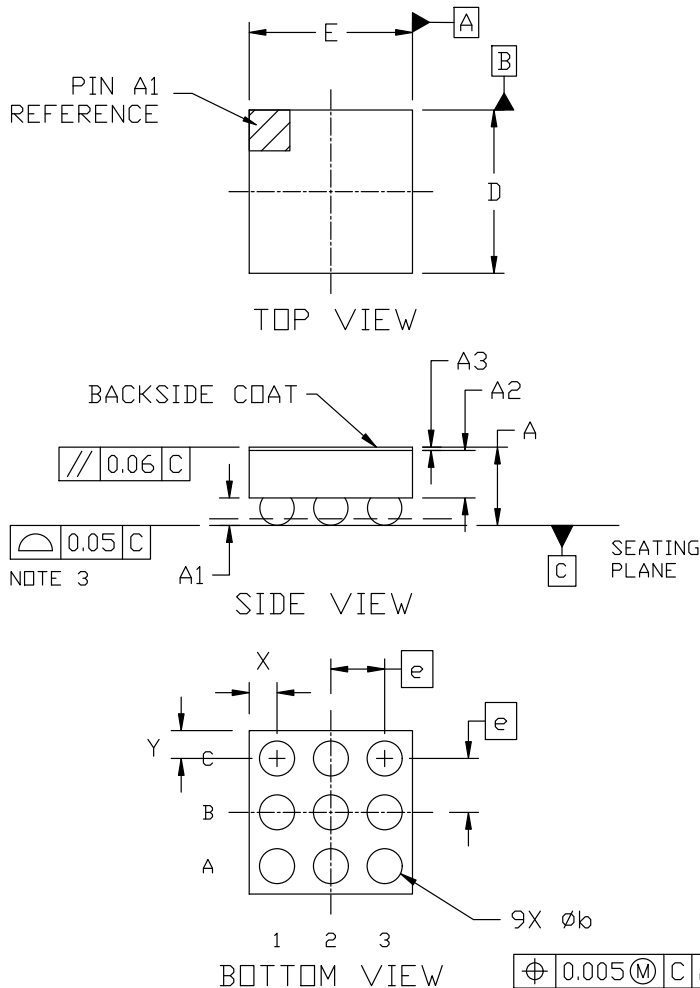
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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WLCSP9 1.215x1.215x0.581
CASE 567QW
ISSUE B

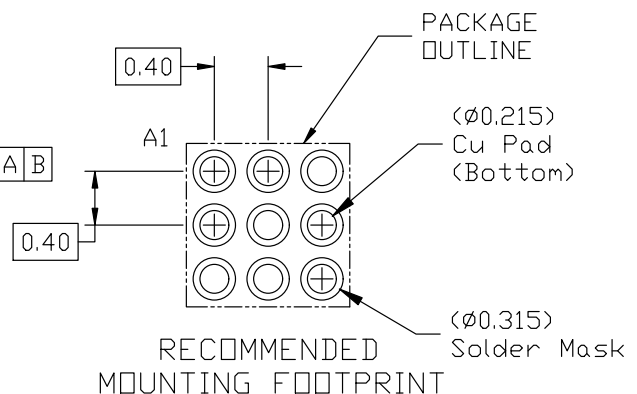
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NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 2009.
2. CONTROLLING DIMENSION: MILLIMETERS
3. COPLANARITY APPLIES TO THE SPHERICAL CROWNS OF THE SOLDER BALLS.
4. DATUM C, THE SEATING PLANE, IS DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
5. DIMENSION b IS MEASURED AT THE MAXIMUM SOLDER BALL DIAMETER PARALLEL TO DATUM C.

DIM	MILLIMETERS		
	MIN.	NOM.	MAX.
A	0.542	0.581	0.620
A1	0.183	0.203	0.223
A2	0.335	0.353	0.371
A3	0.022	0.025	0.027
b	0.24	0.26	0.28
D	1.185	1.215	1.245
E	1.185	1.215	1.245
e	0.400 BSC		
X	0.208 REF		
Y	0.208 REF		



* For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	WLCSP9 1.215x1.215x0.581	PAGE 1 OF 1

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